## 2SC1881(K)

## Silicon NPN Triple Diffused

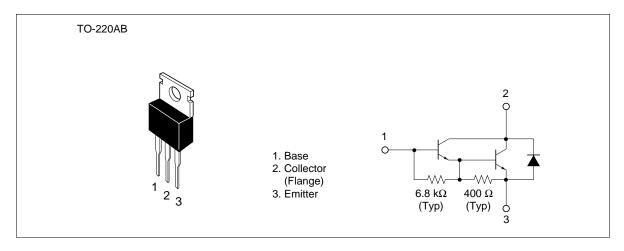
## **HITACHI**

ADE-208-882 (Z) 1st. Edition Sep. 2000

#### **Application**

High gain amplifier power switching

#### **Outline**



### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Collector to base voltage	$V_{CBO}$	60	V
Collector to emitter voltage	V <sub>CEO</sub>	60	V
Emitter to base voltage	$V_{EBO}$	7	V
Collector current	I <sub>c</sub>	3	А
Collector peak current	I <sub>C(peak)</sub>	6	А
Collector power dissipation	P <sub>c</sub> *1	30	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

Note: 1. Value at  $T_c = 25^{\circ}C$ .

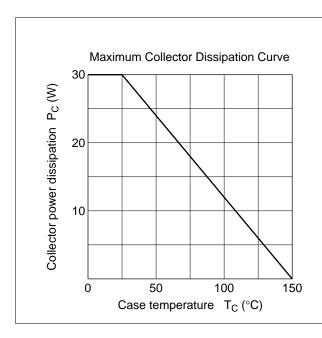


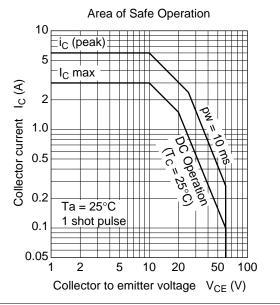
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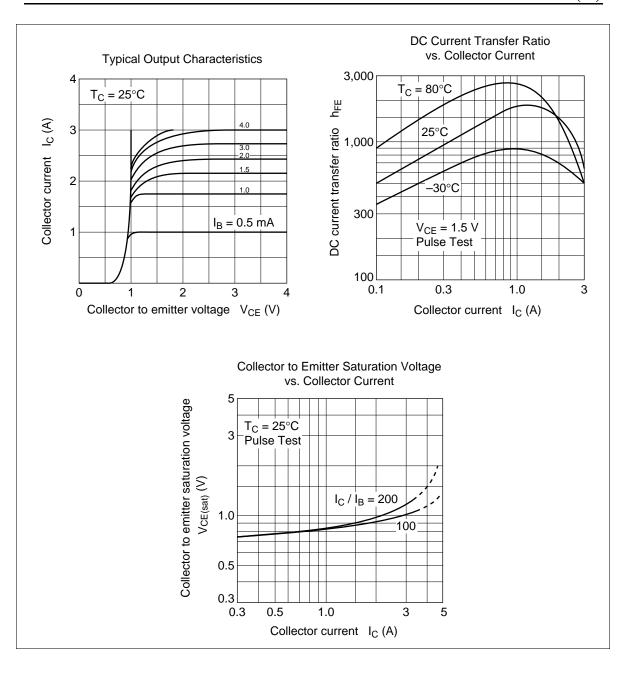
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	Test conditions	
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	60	_	_	V	$I_{\rm C}$ = 50 mA, $R_{\rm BE}$	= ∞
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	_	_	V	$I_E = 50 \text{ mA}, I_C =$	0
Collector cutoff current	I <sub>CBO</sub>		_	0.2	mA	$V_{CB} = 60 \text{ V}, I_{E} = 0$	
_	I <sub>CEO</sub>	_	_	0.4	mA	$V_{CE} = 30 \text{ V}, R_{BE}$	= ∞
DC current transfer ratio	$h_{\text{FE}}$	1000	_	_		$V_{CE} = 1.5 \text{ V}$	$I_{\rm C} = 1.5 \ {\rm A}^{*1}$
		500	_	_			$I_{\rm C} = 2.5 \ {\rm A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	_	_	1.2	V	$I_{\rm C} = 2.5 \text{ A}, I_{\rm B} = 20 \text{ mA}^{*1}$	
Turn on time	t <sub>on</sub>	_	1	_	μs	$V_{CC} = 11 \text{ V}, I_{C} = 2 \text{ A},$	
Turn off time	t <sub>off</sub>	_	5	_	μs	$I_{B1} = -I_{B2} = 8 \text{ mA}$	,

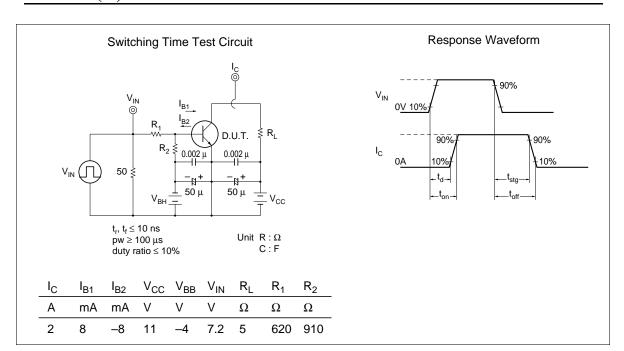
Note: 1. Pulse test.



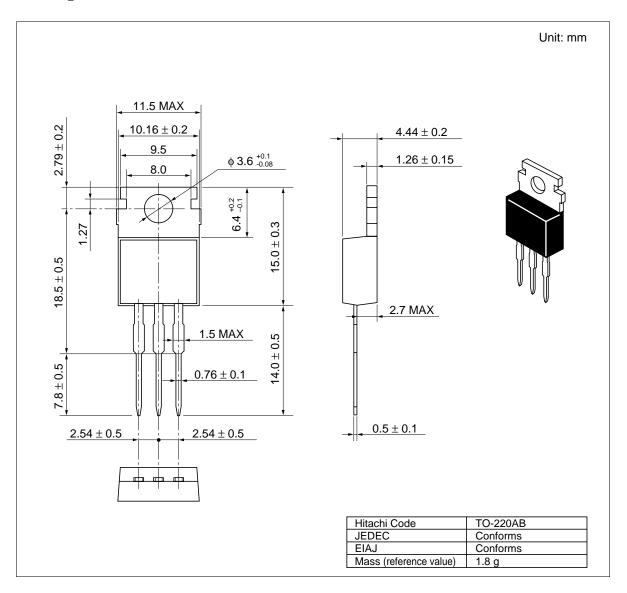




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### **Package Dimensions**



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